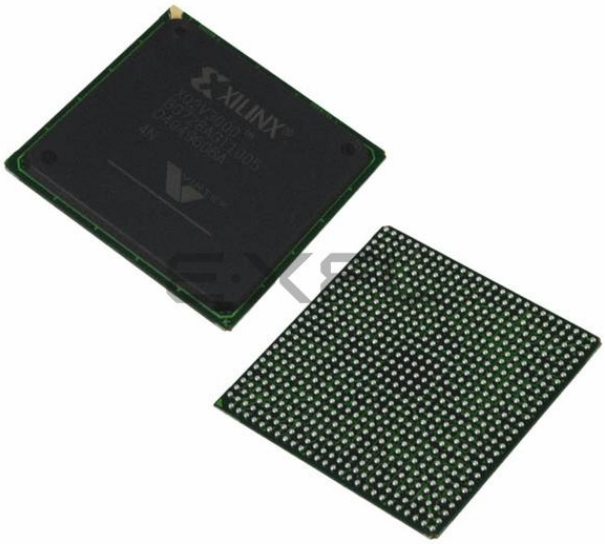

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	3584
Number of Logic Elements/Cells	-
Total RAM Bits	1769472
Number of I/O	516
Number of Gates	3000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	728-BBGA
Supplier Device Package	728-MBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v3000-4bg728i

Table 2: **Supported Differential Signal I/O Standards**

I/O Standard	Output V_{CCO}	Input V_{CCO}	Input V_{REF}	Output V_{OD}
LVPECL_33	3.3	N/R(1)	N/R	0.490 - 1.220
LDT_25	2.5	N/R	N/R	0.500 - 0.700
LVDS_33	3.3	N/R	N/R	0.250 - 0.400
LVDS_25	2.5	N/R	N/R	0.250 - 0.400
LVDSEXT_33	3.3	N/R	N/R	0.440 - 0.820
LVDSEXT_25	2.5	N/R	N/R	0.440 - 0.820
BLVDS_25	2.5	N/R	N/R	0.250 - 0.450
ULVDS_25	2.5	N/R	N/R	0.500 - 0.700

Notes:
1. N/R = no requirement.

Table 3: **Supported DCI I/O Standards**

I/O Standard	Output V_{CCO}	Input V_{CCO}	Input V_{REF}	Termination Type
LVDCI_33(1)	3.3	3.3	N/R(4)	Series
LVDCI_DV2_33(1)	3.3	3.3	N/R	Series
LVDCI_25(1)	2.5	2.5	N/R	Series
LVDCI_DV2_25(1)	2.5	2.5	N/R	Series
LVDCI_18(1)	1.8	1.8	N/R	Series
LVDCI_DV2_18(1)	1.8	1.8	N/R	Series
LVDCI_15(1)	1.5	1.5	N/R	Series
LVDCI_DV2_15(1)	1.5	1.5	N/R	Series
GTL_DCI	1.2	1.2	0.8	Single
GTLP_DCI	1.5	1.5	1.0	Single
HSTL_I_DCI	1.5	1.5	0.75	Split
HSTL_II_DCI	1.5	1.5	0.75	Split
HSTL_III_DCI	1.5	1.5	0.9	Single
HSTL_IV_DCI	1.5	1.5	0.9	Single
HSTL_I_DCI_18	1.8	1.8	0.9	Split
HSTL_II_DCI_18	1.8	1.8	0.9	Split
HSTL_III_DCI_18	1.8	1.8	1.1	Single
HSTL_IV_DCI_18	1.8	1.8	1.1	Single
SSTL18_I_DCI(3)	1.8	1.8	0.9	Split
SSTL18_II_DCI	1.8	1.8	0.9	Split
SSTL2_I_DCI(2)	2.5	2.5	1.25	Split
SSTL2_II_DCI(2)	2.5	2.5	1.25	Split
SSTL3_I_DCI(2)	3.3	3.3	1.5	Split
SSTL3_II_DCI(2)	3.3	3.3	1.5	Split
LVDS_25_DCI	2.5	2.5	N/R	Split
LVDSEXT_25_DCI	2.5	2.5	N/R	Split

Notes:
1. LVDCI_XX and LVDCI_DV2_XX are LVCMOS controlled impedance buffers, matching the reference resistors or half of the reference resistors.
2. These are SSTL compatible.
3. SSTL18_I is not a JEDEC-supported standard.
4. N/R = no requirement.

Logic Resources

IOB blocks include six storage elements, as shown in Figure 2.

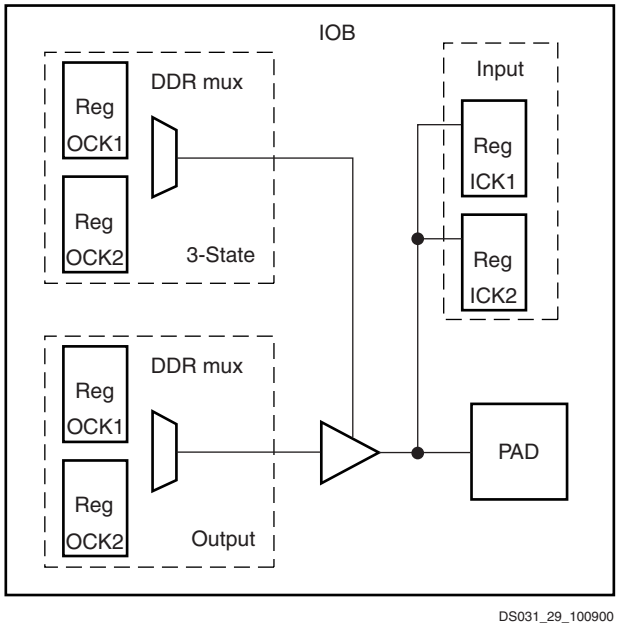

Figure 2: **Virtex-II IOB Block**

Each storage element can be configured either as an edge-triggered D-type flip-flop or as a level-sensitive latch. On the input, output, and 3-state path, one or two DDR registers can be used.

Double data rate is directly accomplished by the two registers on each path, clocked by the rising edges (or falling edges) from two different clock nets. The two clock signals are generated by the DCM and must be 180 degrees out of phase, as shown in Figure 3. There are two input, output, and 3-state data signals, each being alternately clocked out.

Table 4: **LVTTL and LVCMOS Programmable Currents (Sink and Source)**

SelectI/O-Ultra	Programmable Current (Worst-Case Guaranteed Minimum)						
LVTTL	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS33	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS25	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS18	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	n/a
LVCMOS15	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	n/a

Figure 6 shows the SSTL2, SSTL3, and HSTL configurations. HSTL can sink current up to 48 mA. (HSTL IV)

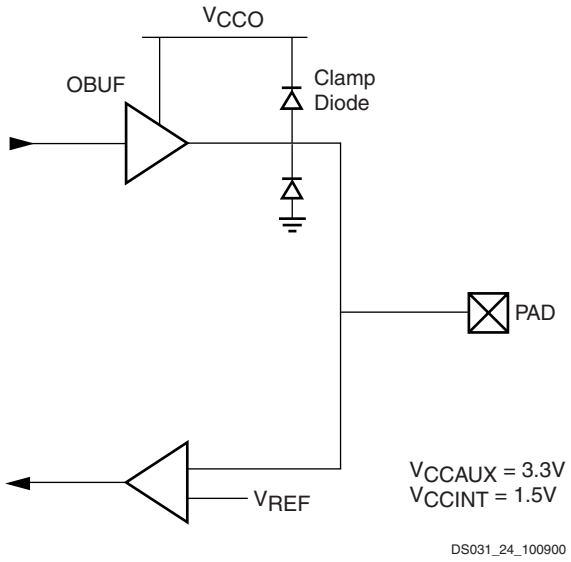

Figure 6: **SSTL or HSTL SelectI/O-Ultra Standards**

All pads are protected against damage from electrostatic discharge (ESD) and from over-voltage transients. Virtex-II uses two memory cells to control the configuration of an I/O as an input. This is to reduce the probability of an I/O configured as an input from flipping to an output when subjected to a single event upset (SEU) in space applications.

Prior to configuration, all outputs not involved in configuration are forced into their high-impedance state. The pull-down resistors and the weak-keeper circuits are inactive. The dedicated pin HSWAP_EN controls the pull-up resistors prior to configuration. By default, HSWAP_EN is set high, which disables the pull-up resistors on user I/O pins. When HSWAP_EN is set low, the pull-up resistors are activated on user I/O pins.

All Virtex-II IOBs support IEEE 1149.1 compatible Boundary-Scan testing.

Input Path

The Virtex-II IOB input path routes input signals directly to internal logic and / or through an optional input flip-flop or latch, or through the DDR input registers. An optional delay element at the D-input of the storage element eliminates pad-to-pad hold time. The delay is matched to the internal clock-distribution delay of the Virtex-II device, and when used, assures that the pad-to-pad hold time is zero.

Each input buffer can be configured to conform to any of the low-voltage signaling standards supported. In some of these standards the input buffer utilizes a user-supplied threshold voltage, V_{REF}. The need to supply V_{REF} imposes constraints on which standards can be used in the same bank. See I/O banking description.

Output Path

The output path includes a 3-state output buffer that drives the output signal onto the pad. The output and / or the 3-state signal can be routed to the buffer directly from the internal logic or through an output / 3-state flip-flop or latch, or through the DDR output / 3-state registers.

Each output driver can be individually programmed for a wide range of low-voltage signaling standards. In most signaling standards, the output High voltage depends on an externally supplied V_{CCO} voltage. The need to supply V_{CCO} imposes constraints on which standards can be used in the same bank. See I/O banking description.

I/O Banking

Some of the I/O standards described above require V_{CCO} and V_{REF} voltages. These voltages are externally supplied and connected to device pins that serve groups of IOB blocks, called banks. Consequently, restrictions exist about which I/O standards can be combined within a given bank.

Eight I/O banks result from dividing each edge of the FPGA into two banks, as shown in Figure 7 and Figure 8. Each bank has multiple V_{CCO} pins, all of which must be connected to the same voltage. This voltage is determined by the output standards in use.

Figure 18, Figure 19, and Figure 20 illustrate various example configurations.

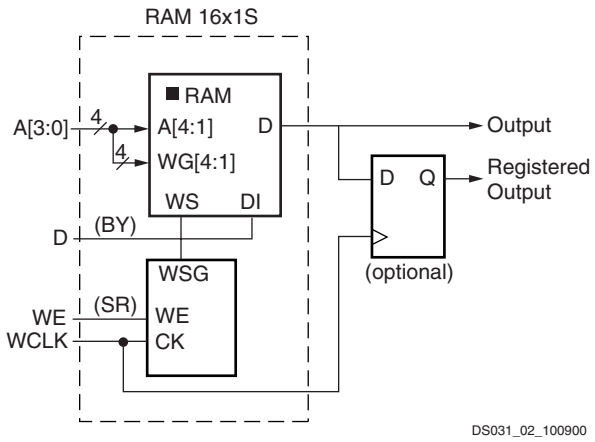

Figure 18: **Distributed SelectRAM (RAM16x1S)**

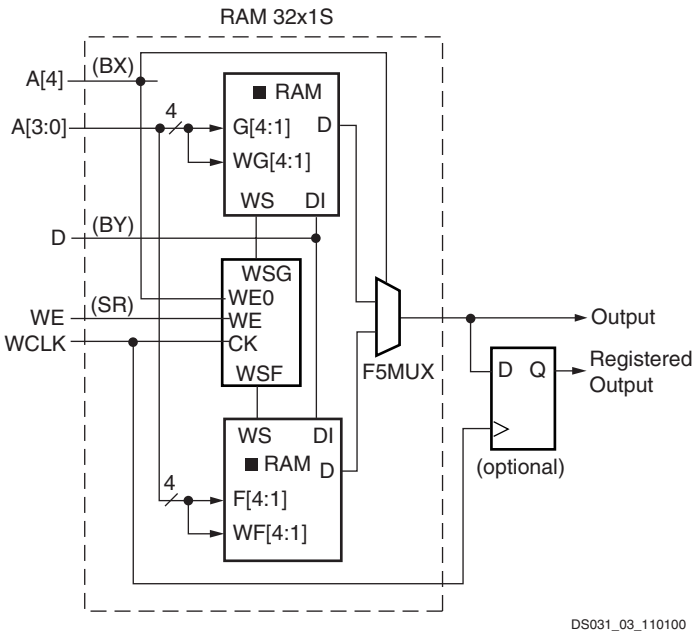

Figure 19: **Single-Port Distributed SelectRAM (RAM32x1S)**

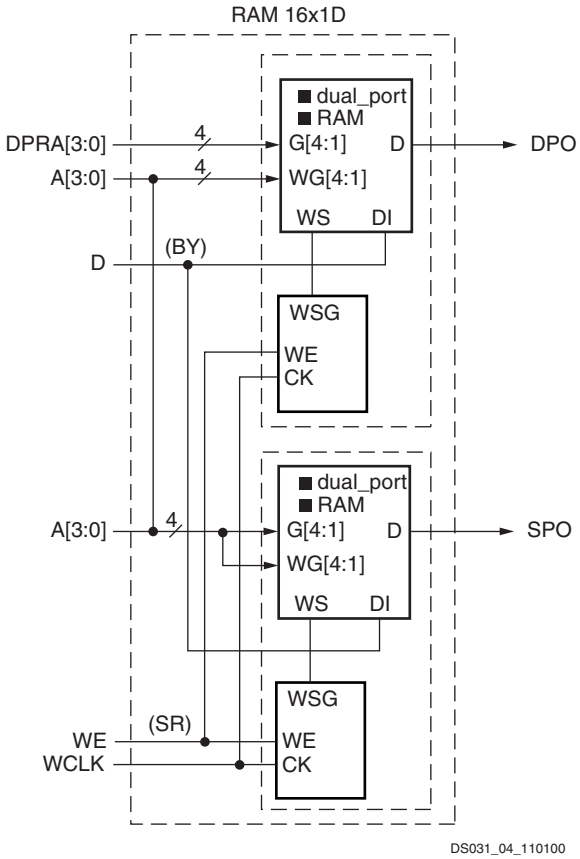

Figure 20: **Dual-Port Distributed SelectRAM (RAM16x1D)**

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 10 shows the number of LUTs occupied by each configuration.

Table 10: **ROM Configuration**

ROM	Number of LUTs
16 x 1	1
32 x 1	2
64 x 1	4
128 x 1	8 (1 CLB)
256 x 1	16 (2 CLBs)

Table 15: **IOB Input Switching Characteristics Standard Adjustments *(Continued)***

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVDCI, 3.3V, Half-Impedance	LVDCI_DV2_33	$T_{ILVDCI\_DV2\_33}$	0.00	0.00	0.00	ns
LVDCI, 2.5V, Half-Impedance	LVDCI_DV2_25	$T_{ILVDCI\_DV2\_25}$	0.11	0.11	0.12	ns
LVDCI, 1.8V, Half-Impedance	LVDCI_DV2_18	$T_{ILVDCI\_DV2\_18}$	0.42	0.43	0.49	ns
LVDCI, 1.5V, Half-Impedance	LVDCI_DV2_15	$T_{ILVDCI\_DV2\_15}$	0.98	1.00	1.14	ns
HSLVDCI (High-Speed Low-Voltage DCI), 1.5V	HSLVDCI_15	$T_{IHSLVDCI\_15}$	0.42	0.42	0.48	ns
HSLVDCI, 1.8V	HSLVDCI_18	$T_{IHSLVDCI\_18}$	0.52	0.53	0.60	ns
HSLVDCI, 2.5V	HSLVDCI_25	$T_{IHSLVDCI\_25}$	0.42	0.42	0.48	ns
HSLVDCI, 3.3V	HSLVDCI_33	$T_{IHSLVDCI\_33}$	0.42	0.42	0.48	ns
GTL (Gunning Transceiver Logic) with DCI	GTL_DCI	T_{IGTL_DCI}	0.42	0.42	0.48	ns
GTL Plus with DCI	GTLP_DCI	T_{IGTLP_DCI}	0.42	0.42	0.48	ns
HSTL (High-Speed Transceiver Logic), Class I, with DCI	HSTL_I_DCI	$T_{IHSTL\_I\_DCI}$	0.42	0.42	0.48	ns
HSTL, Class II, with DCI	HSTL_II_DCI	$T_{IHSTL\_II\_DCI}$	0.42	0.42	0.48	ns
HSTL, Class III, with DCI	HSTL_III_DCI	$T_{IHSTL\_III\_DCI}$	0.42	0.42	0.48	ns
HSTL, Class IV, with DCI	HSTL_IV_DCI	$T_{IHSTL\_IV\_DCI}$	0.42	0.42	0.48	ns
HSTL, Class I, 1.8V, with DCI	HSTL_I_DCI_18	$T_{IHSTL\_I\_DCI\_18}$	0.42	0.42	0.48	ns
HSTL, Class II, 1.8V, with DCI	HSTL_II_DCI_18	$T_{IHSTL\_II\_DCI\_18}$	0.42	0.42	0.48	ns
HSTL, Class III, 1.8V, with DCI	HSTL_III_DCI_18	$T_{IHSTL\_III\_DCI\_18}$	0.42	0.42	0.48	ns
HSTL, Class IV, 1.8V, with DCI	HSTL_IV_DCI_18	$T_{IHSTL\_IV\_DCI\_18}$	0.42	0.42	0.48	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V, with DCI	SSTL18_I_DCI	$T_{ISSTL18\_I\_DCI}$	0.42	0.42	0.48	ns
SSTL, Class II, 1.8V, with DCI	SSTL18_II_DCI	$T_{ISSTL18\_II\_DCI}$	0.42	0.42	0.48	ns
SSTL, Class I, 2.5V, with DCI	SSTL2_I_DCI	$T_{ISSTL2\_I\_DCI}$	0.42	0.42	0.48	ns
SSTL, Class II, 2.5V, with DCI	SSTL2_II_DCI	$T_{ISSTL2\_II\_DCI}$	0.42	0.42	0.48	ns
SSTL, Class I, 3.3V, with DCI	SSTL3_I_DCI	$T_{ISSTL3\_I\_DCI}$	0.35	0.35	0.40	ns
SSTL, Class II, 3.3V, with DCI	SSTL3_II_DCI	$T_{ISSTL3\_II\_DCI}$	0.35	0.35	0.40	ns
LVDS (Low-Voltage Differential Signaling), 2.5V, with DCI	LVDS_25_DCI	$T_{ILVDS\_25\_DCI}$	0.60	0.60	0.69	ns
LVDS, 3.3V, with DCI	LVDS_33_DCI	$T_{ILVDS\_33\_DCI}$	0.60	0.60	0.69	ns
LVDSEXT (LVDS Extended Mode), 2.5V, with DCI	LVDSEXT_25_DCI	$T_{ILVDSEXT\_25\_DCI}$	0.58	0.59	0.79	ns
LVDSEXT, 3.3V, with DCI	LVDSEXT_33_DCI	$T_{ILVDSEXT\_33\_DCI}$	0.56	0.56	0.65	ns

Notes:
1. Input timing for LVTTL is measured at 1.4V. For other I/O standards, see Table 18.

Configuration Timing

Configuration Memory Clearing Parameters

Power-up timing of configuration signals is shown in Figure 2; corresponding timing characteristics are listed in Table 30.

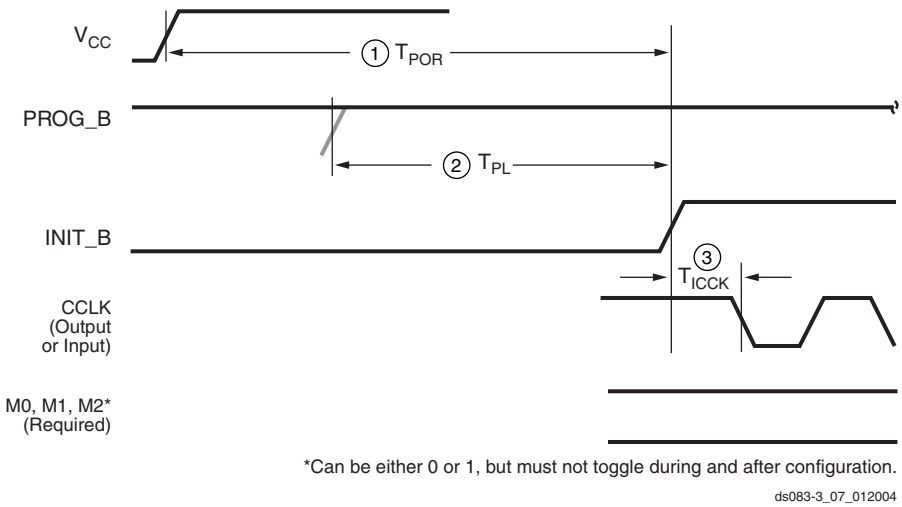

Figure 2: **Configuration Power-Up Timing**

Table 30: **Power-Up Timing Characteristics**

Description	Figure References	Symbol	Value	Units
Power-on reset	1	T_{POR}	T_{PL} + 2	ms, max
Program latency	2	T_{PL}	4	µs per frame, max
CCLK (output) delay	3	T_{ICCK}	0.5	µs, min
			4.0	µs, max
Program pulse width		$T_{PROGRAM}$	300	ns, min

Notes:
1. The M2, M1, and M0 mode pins should be set at a constant DC voltage level, either through pull-up or pull-down resistors, or tied directly to ground or V_{CCAUX}. The mode pins should not be toggled during and after configuration.

Master/Slave Serial Mode Parameters

Clock timing for Slave Serial configuration programming is shown in Figure 3, with Master Serial clock timing shown in Figure 4. Programming parameters for both Slave and Master modes are given in Table 31.

Table 6: **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
NA	GND	T16		
NA	GND	T1		
NA	GND	R15		
NA	GND	R2		
NA	GND	P14		
NA	GND	P3		
NA	GND	L11		
NA	GND	L6		
NA	GND	K10		
NA	GND	K9		
NA	GND	K8		
NA	GND	K7		
NA	GND	J10		
NA	GND	J9		
NA	GND	J8		
NA	GND	J7		
NA	GND	H10		
NA	GND	H9		
NA	GND	H8		
NA	GND	H7		
NA	GND	G10		
NA	GND	G9		
NA	GND	G8		
NA	GND	G7		
NA	GND	F11		
NA	GND	F6		
NA	GND	C14		
NA	GND	C3		
NA	GND	B15		
NA	GND	B2		
NA	GND	A16		
NA	GND	A1		

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
4	IO_L06P_4	Y21		
4	IO_L19N_4	AE24		
4	IO_L19P_4	AF24		
4	IO_L21N_4	AE23		
4	IO_L21P_4/VREF_4	AF23		
4	IO_L22N_4	AE22		
4	IO_L22P_4	AF22		
4	IO_L24N_4	AF21		
4	IO_L24P_4	AF20		
4	IO_L25N_4	AA19	NC	NC
4	IO_L25P_4	AB19	NC	NC
4	IO_L27N_4	AD20	NC	NC
4	IO_L27P_4/VREF_4	AC20	NC	NC
4	IO_L28N_4	AC19	NC	NC
4	IO_L28P_4	AD19	NC	NC
4	IO_L49N_4	AE19		
4	IO_L49P_4	AF19		
4	IO_L51N_4	AA18		
4	IO_L51P_4/VREF_4	AB18		
4	IO_L52N_4	Y18		
4	IO_L52P_4	Y17		
4	IO_L54N_4	AC18		
4	IO_L54P_4	AD18		
4	IO_L67N_4	AE18		
4	IO_L67P_4	AF18		
4	IO_L69N_4	AA17		
4	IO_L69P_4/VREF_4	AB17		
4	IO_L70N_4	AC17		
4	IO_L70P_4	AD17		
4	IO_L72N_4	AF17		
4	IO_L72P_4	AF16		
4	IO_L73N_4	AB16	NC	
4	IO_L73P_4	AC16	NC	
4	IO_L75N_4	AA16	NC	
4	IO_L75P_4/VREF_4	Y16	NC	
4	IO_L76N_4	AD16	NC	
4	IO_L76P_4	AE16	NC	

BG575/BGG575 Standard BGA Package

As shown in Table 9, XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the BG575/BGG575 BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the BG575/BGG575 Standard BGA Package Specifications (1.27mm pitch).

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L01N_0	A3		
0	IO_L01P_0	A4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	E6		
0	IO_L03P_0/VRN_0	D6		
0	IO_L04N_0/VREF_0	F7		
0	IO_L04P_0	E7		
0	IO_L05N_0	G8		
0	IO_L05P_0	H9		
0	IO_L06N_0	A5		
0	IO_L06P_0	A6		
0	IO_L19N_0	B5		
0	IO_L19P_0	B6		
0	IO_L21N_0	D7		
0	IO_L21P_0/VREF_0	C7		
0	IO_L22N_0	F8		
0	IO_L22P_0	E8		
0	IO_L24N_0	G9		
0	IO_L24P_0	F9		
0	IO_L49N_0	G10		
0	IO_L49P_0	H10		
0	IO_L51N_0	B7		
0	IO_L51P_0/VREF_0	B8		
0	IO_L52N_0	D8		
0	IO_L52P_0	C8		
0	IO_L54N_0	E9		
0	IO_L54P_0	D9		
0	IO_L67N_0	A8	NC	
0	IO_L67P_0	A9	NC	
0	IO_L69N_0	C9	NC	

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
4	IO_L91P_4	AB14		
4	IO_L92N_4	V14		
4	IO_L92P_4	Y14		
4	IO_L93N_4	AB13		
4	IO_L93P_4	AC13		
4	IO_L94N_4/VREF_4	Y13		
4	IO_L94P_4	AA13		
4	IO_L95N_4/GCLK3S	V13		
4	IO_L95P_4/GCLK2P	W13		
4	IO_L96N_4/GCLK1S	U14		
4	IO_L96P_4/GCLK0P	U13		
5	IO_L96N_5/GCLK7S	AD12		
5	IO_L96P_5/GCLK6P	AD11		
5	IO_L95N_5/GCLK5S	AC12		
5	IO_L95P_5/GCLK4P	AB12		
5	IO_L94N_5	AA12		
5	IO_L94P_5/VREF_5	Y12		
5	IO_L93N_5	W12		
5	IO_L93P_5	V12		
5	IO_L92N_5	U12		
5	IO_L92P_5	U11		
5	IO_L91N_5	AB11		
5	IO_L91P_5/VREF_5	AA11		
5	IO_L73N_5	Y11	NC	NC
5	IO_L73P_5	V11	NC	NC
5	IO_L72N_5	AD10	NC	
5	IO_L72P_5	AD9	NC	
5	IO_L70N_5	AC10	NC	
5	IO_L70P_5	AB10	NC	
5	IO_L69N_5/VREF_5	Y10	NC	
5	IO_L69P_5	W10	NC	
5	IO_L67N_5	V10	NC	
5	IO_L67P_5	U10	NC	
5	IO_L54N_5	AC9		
5	IO_L54P_5	AB9		

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
3	IO_L73P_3	W4	NC	NC
3	IO_L72N_3	W7	NC	
3	IO_L72P_3	V7	NC	
3	IO_L71N_3	V5	NC	
3	IO_L71P_3	W6	NC	
3	IO_L70N_3	W3	NC	
3	IO_L70P_3	Y3	NC	
3	IO_L69N_3/VREF_3	V8	NC	
3	IO_L69P_3	W8	NC	
3	IO_L68N_3	AA1	NC	
3	IO_L68P_3	AB1	NC	
3	IO_L67N_3	Y4	NC	
3	IO_L67P_3	AA4	NC	
3	IO_L54N_3	AA6		
3	IO_L54P_3	Y6		
3	IO_L53N_3	AA2		
3	IO_L53P_3	AB2		
3	IO_L52N_3	Y5		
3	IO_L52P_3	AA5		
3	IO_L51N_3/VREF_3	Y8		
3	IO_L51P_3	AA8		
3	IO_L50N_3	AC2		
3	IO_L50P_3	AD2		
3	IO_L49N_3	Y7		
3	IO_L49P_3	AA7		
3	IO_L48N_3	AC6		
3	IO_L48P_3	AB6		
3	IO_L47N_3	AD1		
3	IO_L47P_3	AE1		
3	IO_L46N_3	AB3		
3	IO_L46P_3	AC3		
3	IO_L45N_3/VREF_3	AB7		
3	IO_L45P_3	AC7		
3	IO_L44N_3	AB4		
3	IO_L44P_3	AC4		
3	IO_L43N_3	AB5		
3	IO_L43P_3	AC5		

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
4	IO_L73P_4	AJ12	NC	NC
4	IO_L74N_4	AE13	NC	NC
4	IO_L74P_4	AE14	NC	NC
4	IO_L75N_4	AF13	NC	NC
4	IO_L75P_4/VREF_4	AG13	NC	NC
4	IO_L76N_4	AK13	NC	NC
4	IO_L76P_4	AK12	NC	NC
4	IO_L77N_4	AB14	NC	NC
4	IO_L77P_4	AB15	NC	NC
4	IO_L78N_4	AF15	NC	NC
4	IO_L78P_4	AF14	NC	NC
4	IO_L91N_4/VREF_4	AJ14		
4	IO_L91P_4	AJ15		
4	IO_L92N_4	AC14		
4	IO_L92P_4	AC15		
4	IO_L93N_4	AG15		
4	IO_L93P_4	AG14		
4	IO_L94N_4/VREF_4	AK14		
4	IO_L94P_4	AK15		
4	IO_L95N_4/GCLK3S	AD15		
4	IO_L95P_4/GCLK2P	AE15		
4	IO_L96N_4/GCLK1S	AH14		
4	IO_L96P_4/GCLK0P	AH15		
5	IO_L96N_5/GCLK7S	AH16		
5	IO_L96P_5/GCLK6P	AH17		
5	IO_L95N_5/GCLK5S	AE16		
5	IO_L95P_5/GCLK4P	AD16		
5	IO_L94N_5	AJ16		
5	IO_L94P_5/VREF_5	AJ17		
5	IO_L93N_5	AG17		
5	IO_L93P_5	AG16		
5	IO_L92N_5	AC16		
5	IO_L92P_5	AC17		
5	IO_L91N_5	AK17		
5	IO_L91P_5/VREF_5	AK18		
5	IO_L78N_5	AF17	NC	NC

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
NA	GND	AC1		
NA	GND	AA28		
NA	GND	AA3		
NA	GND	W26		
NA	GND	W19		
NA	GND	W18		
NA	GND	W17		
NA	GND	W16		
NA	GND	W15		
NA	GND	W14		
NA	GND	W13		
NA	GND	W12		
NA	GND	W5		
NA	GND	V19		
NA	GND	V18		
NA	GND	V17		
NA	GND	V16		
NA	GND	V15		
NA	GND	V14		
NA	GND	V13		
NA	GND	V12		
NA	GND	U24		
NA	GND	U19		
NA	GND	U18		
NA	GND	U17		
NA	GND	U16		
NA	GND	U15		
NA	GND	U14		
NA	GND	U13		
NA	GND	U12		
NA	GND	U7		
NA	GND	T19		
NA	GND	T18		
NA	GND	T17		
NA	GND	T16		
NA	GND	T15		
NA	GND	T14		

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	AE32	
NA	GND	AE3	
NA	GND	AC30	
NA	GND	AC5	
NA	GND	AA28	
NA	GND	AA21	
NA	GND	AA20	
NA	GND	AA19	
NA	GND	AA18	
NA	GND	AA17	
NA	GND	AA16	
NA	GND	AA15	
NA	GND	AA14	
NA	GND	AA7	
NA	GND	Y33	
NA	GND	Y21	
NA	GND	Y20	
NA	GND	Y19	
NA	GND	Y18	
NA	GND	Y17	
NA	GND	Y16	
NA	GND	Y15	
NA	GND	Y14	
NA	GND	Y2	
NA	GND	W26	
NA	GND	W21	
NA	GND	W20	
NA	GND	W19	
NA	GND	W18	
NA	GND	W17	
NA	GND	W16	
NA	GND	W15	
NA	GND	W14	
NA	GND	W9	
NA	GND	V21	
NA	GND	V20	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	P20	
NA	GND	P19	
NA	GND	P18	
NA	GND	P17	
NA	GND	P16	
NA	GND	P15	
NA	GND	P14	
NA	GND	P7	
NA	GND	M30	
NA	GND	M5	
NA	GND	K32	
NA	GND	K3	
NA	GND	J19	
NA	GND	J16	
NA	GND	H34	
NA	GND	H27	
NA	GND	H8	
NA	GND	H1	
NA	GND	G28	
NA	GND	G21	
NA	GND	G14	
NA	GND	G7	
NA	GND	F29	
NA	GND	F6	
NA	GND	E30	
NA	GND	E23	
NA	GND	E12	
NA	GND	E5	
NA	GND	D31	
NA	GND	D4	
NA	GND	C34	
NA	GND	C32	
NA	GND	C25	
NA	GND	C10	
NA	GND	C3	
NA	GND	C1	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
3	IO_L82N_3	AA4		
3	IO_L82P_3	AB4		
3	IO_L81N_3/VREF_3	AB11		
3	IO_L81P_3	AA11		
3	IO_L80N_3	AC1		
3	IO_L80P_3	AD1		
3	IO_L79N_3	AA7		
3	IO_L79P_3	AB7		
3	IO_L78N_3	AB12		
3	IO_L78P_3	AA12		
3	IO_L77N_3	AC2		
3	IO_L77P_3	AC3		
3	IO_L76N_3	AB5		
3	IO_L76P_3	AC5		
3	IO_L75N_3/VREF_3	AD9		
3	IO_L75P_3	AC9		
3	IO_L74N_3	AD2		
3	IO_L74P_3	AE2		
3	IO_L73N_3	AB6		
3	IO_L73P_3	AC6		
3	IO_L72N_3	AD10		
3	IO_L72P_3	AC10		
3	IO_L71N_3	AD3		
3	IO_L71P_3	AE3		
3	IO_L70N_3	AC7		
3	IO_L70P_3	AD7		
3	IO_L69N_3/VREF_3	AE8		
3	IO_L69P_3	AD8		
3	IO_L68N_3	AE1		
3	IO_L68P_3	AF1		
3	IO_L67N_3	AD4		
3	IO_L67P_3	AE4		
3	IO_L60N_3	AD12		
3	IO_L60P_3	AC12		
3	IO_L59N_3	AF3		
3	IO_L59P_3	AG3		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
4	IO_L32P_4	AM14	NC	
4	IO_L33N_4	AT10	NC	
4	IO_L33P_4/VREF_4	AT9	NC	
4	IO_L34N_4	AV10	NC	
4	IO_L34P_4	AV9	NC	
4	IO_L35N_4	AH16	NC	
4	IO_L35P_4	AH17	NC	
4	IO_L36N_4	AP13	NC	
4	IO_L36P_4	AP12	NC	
4	IO_L49N_4	AU12		
4	IO_L49P_4	AU11		
4	IO_L50N_4	AK15		
4	IO_L50P_4	AJ16		
4	IO_L51N_4	AT12		
4	IO_L51P_4/VREF_4	AT11		
4	IO_L52N_4	AN15		
4	IO_L52P_4	AN14		
4	IO_L53N_4	AR12		
4	IO_L53P_4	AR13		
4	IO_L54N_4	AT14		
4	IO_L54P_4	AT13		
4	IO_L55N_4	AW11		
4	IO_L55P_4	AW10		
4	IO_L56N_4	AM15		
4	IO_L56P_4	AM16		
4	IO_L57N_4	AP15		
4	IO_L57P_4/VREF_4	AP14		
4	IO_L58N_4	AV13		
4	IO_L58P_4	AV12		
4	IO_L59N_4	AK16		
4	IO_L59P_4	AK17		
4	IO_L60N_4	AR16		
4	IO_L60P_4	AR15		
4	IO_L67N_4	AW13		
4	IO_L67P_4	AW12		
4	IO_L68N_4	AL16		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L25N_5	AV33		
5	IO_L25P_5	AV32		
5	IO_L24N_5	AR31		
5	IO_L24P_5	AR30		
5	IO_L23N_5	AL27		
5	IO_L23P_5	AL28		
5	IO_L22N_5	AW34		
5	IO_L22P_5	AW33		
5	IO_L21N_5/VREF_5	AN30		
5	IO_L21P_5	AP30		
5	IO_L20N_5	AM28		
5	IO_L20P_5	AM29		
5	IO_L19N_5	AU33		
5	IO_L19P_5	AU32		
5	IO_L12N_5	AT33	NC	
5	IO_L12P_5	AT32	NC	
5	IO_L11N_5	AK27	NC	
5	IO_L11P_5	AK28	NC	
5	IO_L10N_5	AV35	NC	
5	IO_L10P_5	AV34	NC	
5	IO_L09N_5/VREF_5	AP32	NC	
5	IO_L09P_5	AP31	NC	
5	IO_L08N_5	AL29	NC	
5	IO_L08P_5	AK29	NC	
5	IO_L07N_5	AW36	NC	
5	IO_L07P_5	AW35	NC	
5	IO_L06N_5	AR33		
5	IO_L06P_5	AR32		
5	IO_L05N_5/VRP_5	AM30		
5	IO_L05P_5/VRN_5	AL30		
5	IO_L04N_5	AU35		
5	IO_L04P_5/VREF_5	AU34		
5	IO_L03N_5/D4/ALT_VRP_5	AR34		
5	IO_L03P_5/D5/ALT_VRN_5	AT34		
5	IO_L02N_5/D6	AN31		
5	IO_L02P_5/D7	AM31		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L02P_7/VRN_7	M27		
7	IO_L02N_7/VRP_7	L27		
7	IO_L01P_7	D38		
7	IO_L01N_7	E37		
0	VCCO_0	P25		
0	VCCO_0	P24		
0	VCCO_0	P23		
0	VCCO_0	P22		
0	VCCO_0	P21		
0	VCCO_0	N26		
0	VCCO_0	N25		
0	VCCO_0	N24		
0	VCCO_0	N23		
0	VCCO_0	N22		
0	VCCO_0	N21		
0	VCCO_0	L23		
0	VCCO_0	J25		
0	VCCO_0	G27		
0	VCCO_0	E29		
0	VCCO_0	C22		
0	VCCO_0	B26		
1	VCCO_1	P19		
1	VCCO_1	P18		
1	VCCO_1	P17		
1	VCCO_1	P16		
1	VCCO_1	P15		
1	VCCO_1	N19		
1	VCCO_1	N18		
1	VCCO_1	N17		
1	VCCO_1	N16		
1	VCCO_1	N15		
1	VCCO_1	N14		
1	VCCO_1	L17		
1	VCCO_1	J15		
1	VCCO_1	G13		

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	DXP	B28	
NA	VBATT	D5	
NA	RSVD	B4	
NA	VCCAUX	B16	
NA	VCCAUX	C2	
NA	VCCAUX	C30	
NA	VCCAUX	T2	
NA	VCCAUX	T30	
NA	VCCAUX	AJ2	
NA	VCCAUX	AJ30	
NA	VCCAUX	AK16	
NA	VCCINT	K15	
NA	VCCINT	K17	
NA	VCCINT	L11	
NA	VCCINT	L16	
NA	VCCINT	L21	
NA	VCCINT	M12	
NA	VCCINT	M16	
NA	VCCINT	M20	
NA	VCCINT	N13	
NA	VCCINT	N14	
NA	VCCINT	N15	
NA	VCCINT	N16	
NA	VCCINT	N17	
NA	VCCINT	N18	
NA	VCCINT	N19	
NA	VCCINT	P13	
NA	VCCINT	P19	
NA	VCCINT	R10	
NA	VCCINT	R13	
NA	VCCINT	R19	
NA	VCCINT	R22	
NA	VCCINT	T11	
NA	VCCINT	T12	
NA	VCCINT	T13	
NA	VCCINT	T19	
NA	VCCINT	T20	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	GND	AG27	
NA	GND	AH4	
NA	GND	AH10	
NA	GND	AH16	
NA	GND	AH22	
NA	GND	AH28	
NA	GND	AJ1	
NA	GND	AJ3	
NA	GND	AJ29	
NA	GND	AJ31	
NA	GND	AK1	
NA	GND	AK2	
NA	GND	AK8	
NA	GND	AK24	
NA	GND	AK30	
NA	GND	AK31	
NA	GND	AL2	
NA	GND	AL3	
NA	GND	AL16	
NA	GND	AL29	
NA	GND	AL30	

Notes:
1. See Table 4 for an explanation of the signals available on this pin.